Unit: mm

TOSHIBA Field-Effect Transistor Silicon N-Channel MOS Type (U-MOS VII-H)

SSM3K333R

- O Power Management Switch Applications
- High-Speed Switching Applications
- 4.5V drive
- Low ON-resistance: $R_{DS(ON)}$ = 42 m Ω (max) (@V_{GS} = 4.5 V) : $R_{DS(ON)}$ = 28 m Ω (max) (@V_{GS} = 10 V)

Absolute Maximum Ratings (Ta = 25°C)

Characteristic		Symbol		Rating	Unit	
Drain-source voltage		V_{DSS}		30	V	
Gate-source voltage		V _{GSS}		±20	V	
Drain current	DC	I _D (Note1)		6	Α	
	Pulse	I _{DP} (Note1)		12		
Power dissipation		P _D (Note 2)		1	W	
			t = 10s	2	VV	
Channel temperature		T _{ch}		150	°C	
Storage temperature range		T _{stg}		-55 to 150	°C	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the

1. Gate
2. Source
3. Drain

SOT-23F

JEDEC

JEITA

TOSHIBA

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Weight: 11 mg (typ.)

reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

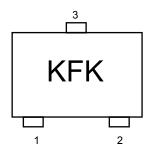
Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: The channel temperature should not exceed 150°C during use.

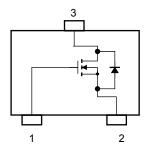
Note 2: Mounted on a FR4 board.

 $(25.4 \text{ mm} \times 25.4 \text{ mm} \times 1.6 \text{ mm}, \text{ Cu Pad: } 645 \text{ mm}^2)$

Marking



Equivalent Circuit (top view)



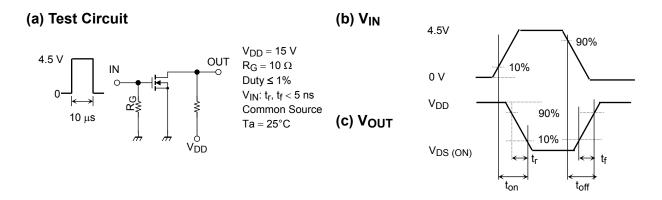
Start of commercial production 2010-10

Electrical Characteristics (Ta = 25°C)

Chara	acteristic	Symbol	Test Conditions	Min	Тур.	Max	Unit
Drain-source breakdown voltage		V (BR) DSS	$I_D = 10$ mA, $V_{GS} = 0$ V	30	_	_	V
		V (BR) DSX	$I_D = 10$ mA, $V_{GS} = -20$ V	15	_	_	
Drain cut-off curre	ent	I _{DSS}	V _{DS} = 30 V, V _{GS} = 0 V	_	_	1	μА
Gate leakage curr	ent	I _{GSS}	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$	_	_	±0.1	μА
Gate threshold vo	Itage	V_{th}	V _{DS} = 10 V, I _D = 0.1 mA	1.3	_	2.5	V
Forward transfer a	admittance	Y _{fs}	$V_{DS} = 10 \text{ V}, I_D = 5 \text{ A}$ (Note 3)	12	24	_	S
Drain-source ON-resistance		R _{DS (ON)}	$I_D = 3.0 \text{ A}, V_{GS} = 4.5 \text{ V}$ (Note 3)	_	25.7	42	mΩ
			$I_D = 5.0 \text{ A}, V_{GS} = 10 \text{ V}$ (Note 3)	_	18.7	28	
Input capacitance		C _{iss}		_	436	_	
Output capacitance		Coss	V _{DS} = 15V, V _{GS} = 0 V, f = 1 MHz	_	77	_	pF
Reverse transfer capacitance		C _{rss}		_	28	_	
Total gate charge Gate-source charge		Qg	\\ = 45\\ - = 6.0 A	_	3.4	_	nC
		Q _{gs1}	$V_{DD} = 15V, I_D = 6.0 A$ $V_{GS} = 4.5V$	_	1.8	_	
Gate-drain charge		Q _{gd}	1 465 - 4.54	_	1.0	_	
Switching time	Turn-on time	t _{on}	V _{DD} = 15 V, I _D = 3.0 A,	_	12	_	ne
	Turn-off time	t _{off}	$V_{GS} = 0$ to 4.5 V, $R_G = 10 \Omega$	_	9	_	ns
Drain-source forward voltage		V _{DSF}	$I_D = -6.0 \text{ A}, V_{GS} = 0 \text{ V}$ (Note 3)	_	-0.85	-1.2	V

Note 3: Pulse test

Switching Time Test Circuit



Usage Considerations

Let V_{th} be the voltage applied between gate and source that causes the drain current (I_D) to below (0.1 mA for the SSM3K333R). Then, for normal switching operation, $V_{GS(on)}$ must be higher than V_{th} , and $V_{GS(off)}$ must be lower than V_{th} . This relationship can be expressed as: $V_{GS(off)} < V_{th} < V_{GS(on)}$.

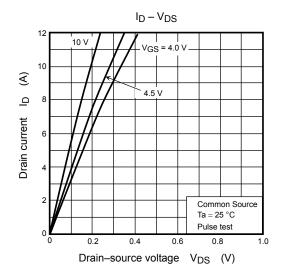
Take this into consideration when using the device.

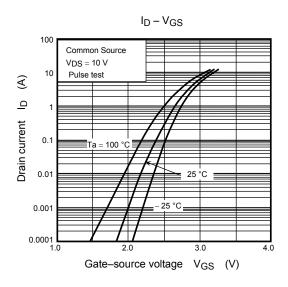
Handling Precaution

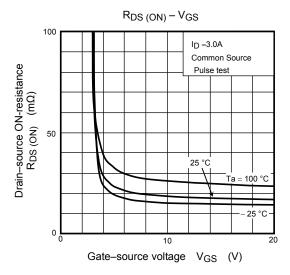
When handling individual devices that are not yet mounted on a circuit board, make sure that the environment is protected against electrostatic discharge. Operators should wear antistatic clothing, and containers and other objects that come into direct contact with devices should be made of antistatic materials.

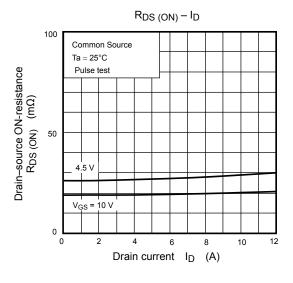
Thermal resistance $R_{th\ (ch-a)}$ and Power dissipation P_D vary depending on board material, board area, board thickness and pad area. When using this device, please take heat dissipation into consideration.

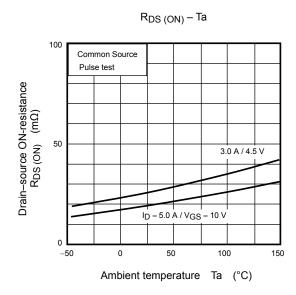
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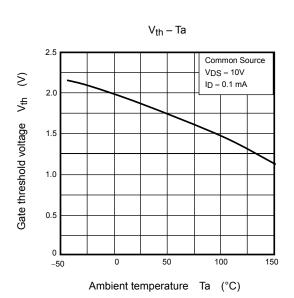


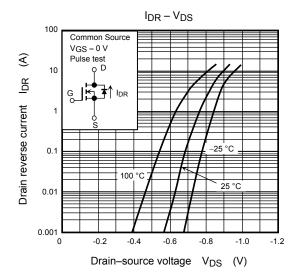


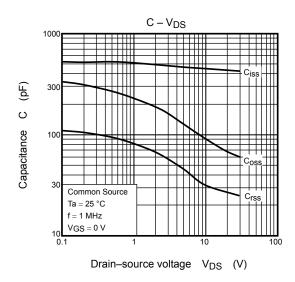


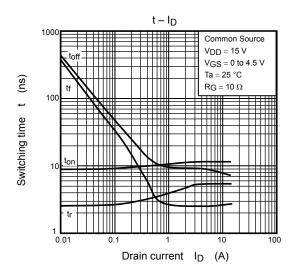


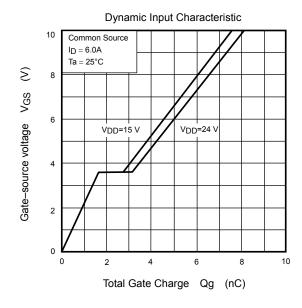


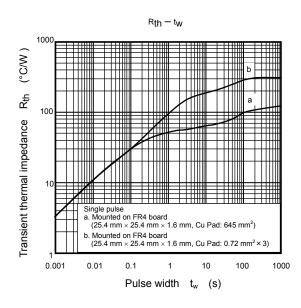


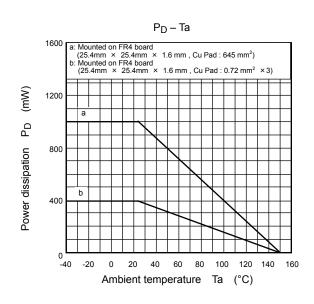












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